

TECHNICAL DATA DATA SHEET 319, REV. B

# HERMETIC POWER MOSFET N-CHANNEL QUAD

### FEATURES:

- 100 Volt, 0.35 Ohm, 6.2A MOSFET
- Fast Switching
- Low R<sub>DS (on)</sub>
- Equivalent to IRF120 Series

### MAXIMUM RATINGS

### ALL RATINGS ARE AT $T_c = 25^{\circ}C$ UNLESS OTHERWISE SPECIFIED.

RATING	SYMBOL	MIN.	TYP.	MAX.	UNITS
GATE TO SOURCE VOLTAGE	V <sub>GS</sub>	-	-	±20	Volts
ON-STATE DRAIN CURRENT @ $T_c = 25^{\circ}C$	ID	-	-	6.2	Amps
PULSED DRAIN CURRENT (10ms)	IDM	-	-	12	Amps
OPERATING AND STORAGE TEMPERATURE	T <sub>OP</sub> /T <sub>STG</sub>	-55	-	+150	°C
TOTAL DEVICE DISSIPATION @ Tc = 25°C	PD	-	-	27	Watts
THERMAL RESISTANCE, JUNCTION TO CASE	RthJC	-	-	4.7	°C/W

## **ELECTRICAL CHARACTERISTICS**

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNITS
DRAIN TO SOURCE BREAKDOWN VOLTAGE	BV <sub>DSS</sub>	100	-	-	Volts
$V_{GS} = 0V, I_D = 250 \mu A$	A				
STATIC DRAIN TO SOURCE ON STATE RESISTANCE	RDS(ON)	-	-	0.35	Ω
$V_{GS} = 10V, I_D = 0.6x \text{ rated } I_D$					
GATE THRESHOLD VOLTAGE $V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	VGS(th)	2.0	-	4.0	Volts
FORWARD TRANSCONDUCTANCE (see Note)	<b>g</b> fs	2.7	4.1	-	S(1/Ω)
$V_{DS} \ge I_{D (ON)} X R_{DS (ON)} Max., I_{DS} = 0.6 X I_{DS}$	)				
ZERO GATE VOLTAGE DRAIN CURRENT		-	-		
$V_{DS} = Max. Rating, V_{GS} = 0V$	IDSS			250	μA
$V_{DS} = 0.8 \text{xMax}$ . Rating, $V_{GS} = 0 \text{V}$ , $T_J = 125 \text{°C}$				1000	•
GATE TO SOURCE LEAKAGE FORWARD VGS = 20V	/ Igss	-	-	100	nA
GATE TO SOURCE LEAKAGE REVERSE V <sub>GS</sub> = -20 <sup>V</sup>	V			-100	
TURN ON DELAY TIME V <sub>DD</sub> = 50V	, t <sub>d(ON)</sub>	-	8.8	13	
RISE TIME $I_D = .5 x I_D$	, t <sub>r</sub>		30	45	nsec
TURN OFF DELAY TIME $R_G = 18\Omega$	, td(OFF)		19	29	
FALL TIME $V_{GS} = 10V$	/ t <sub>f</sub>		20	30	
DIODE FORWARD VOLTAGE $T_c = 25^{\circ}C, I_s = I_c$	o, V <sub>SD</sub>	-	-	2.5	Volts
$V_{GS} = 0^{V}$	V				
REVERSE RECOVERY TIME $T_J = 25^{\circ}C$	, t <sub>rr</sub>	55	110	240	
$I_{f} = I_{D}$	,				nsec
di⊧/ds = 100A/µsec	;,				
INPUT CAPACITANCE V <sub>GS</sub> = 0 V	Ciss	-	350	-	
OUTPUT CAPACITANCE V <sub>DS</sub> = 25 V	Coss		130		pF
REVERSE TRANSFER CAPACITANCE f = 1.0MHz	Crss		36		

Note: This parameter is guaranteed by design, not tested in production.

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**MECHANICAL DIMENSIONS: in Inches / m** 

LCC-28T

#### **PINOUT TABLE**

QUAD MOSFET LCC-28T	GATE	DRAIN	SOURCE
MOSFET 1	PIN 1	PINS 5, 6, 7	PINS 2, 3, 4
MOSFET 2	PIN 8	PINS 9, 10, 11	PINS 12, 13, 14
MOSFET 3	PIN 15	PINS 19, 20, 21	PINS 16, 17, 18
MOSFET 4	PIN 22	PINS 23, 24, 25	PINS 26, 27, 28

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